# MBR0530T1G, NRVB0530T1G, MBR0530T3G, NRVB0530T3G

# Surface Mount Schottky Power Rectifier

## Plastic SOD-123 Package

The MBR0530T1/3 uses the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. These state-of-the-artdevices have the following features:

#### Features

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL 94, V-0 @ 0.125 in
- Package Designed for Optimal Automated Board Assembly
- AEC-Q101 Qualified and PPAP Capable
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements
- All Packages are Pb-Free\*

#### **Mechanical Characteristics**

- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded

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- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



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## SCHOTTKY BARRIER RECTIFIER 0.5 AMPERES 30 VOLTS



SOD-123 CASE 425 STYLE 1

#### MARKING DIAGRAM





= Pb-Free Package

(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>		
MBR0530T1G	SMB (Pb-Free)	3,000 / Tape & Reel **		
NRVB0530T1G	SMB (Pb-Free)	3,000 / Tape & Reel **		
MBR0530T3G	SMB (Pb-Free)	10.000 / Tape & Reel ***		
NRVB0530T3G	SMB (Pb-Free)	10.000 / Tape & Reel ***		

\*\* 8 mm Tape, 7" Reel

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\*\*\* 8 mm Tape, 13" Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

Fublication Order Number: MBR0530T1/D

### MBR0530T1G, NRVB0530T1G, MBR0530T3G, NRVB0530T3G

#### MAXIMUM RATINGS

Rating		Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (Rated $V_R$ , $T_L$ = 100°C)	I <sub>F(AV)</sub>	0.5	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	5.5	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Operating Junction Temperature	ТJ	-65 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	1000	V/µs
ESD Rating: Machine Model = C Human Body Model = 3B		> 400 > 8000	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance – Junction-to-Ambient (Note 1)	$R_{\thetaJA}$	206	°C/W
Thermal Resistance – Junction-to-Lead	$R_{\theta JL}$	150	°C/W

1. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 2) ( $i_F = 0.1 \text{ Amps}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 0.5 \text{ Amps}, T_J = 25^{\circ}\text{C}$ )	VF	0.375 0.43	V
Maximum Instantaneous Reverse Current (Note 2) (Rated DC Voltage, $T_C = 25^{\circ}C$ ) ( $V_R = 15 V$ , $T_C = 25^{\circ}C$ )	I <sub>R</sub>	130 20	μΑ

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2%.

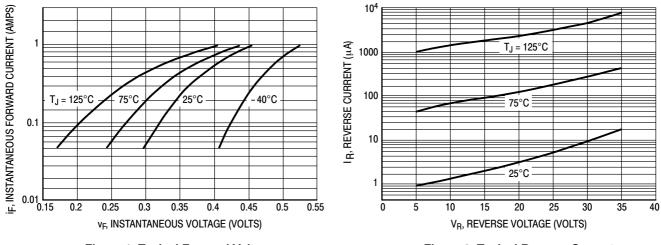


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

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### MBR0530T1G, NRVB0530T1G, MBR0530T3G, NRVB0530T3G

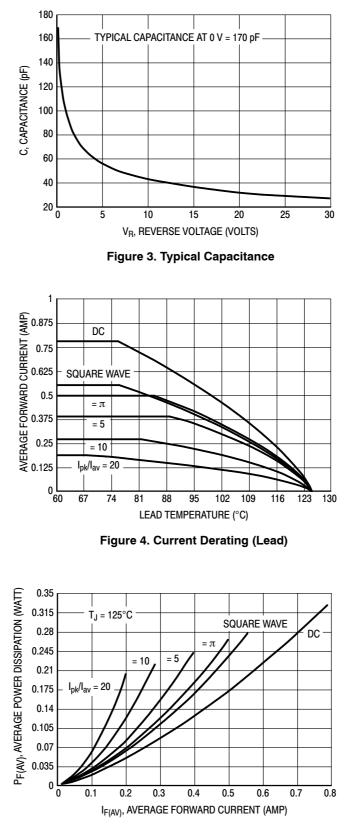


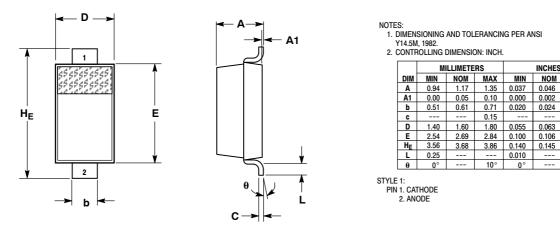
Figure 5. Power Dissipation

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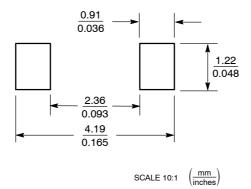
#### MBR0530T1G, NRVB0530T1G, MBR0530T3G, NRVB0530T3G

#### PACKAGE DIMENSIONS

SOD-123 CASE 425-04 ISSUE G



SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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